

Title (en)

METHOD FOR MONITORING THE MACHINING OF, AND APPARATUS FOR MACHINING, A WORKPIECE WITH A HIGH-ENERGY PROCESSING BEAM

Title (de)

VERFAHREN ZUM ÜBERWACHEN DER BEARBEITUNG SOWIE VORRICHTUNG ZUM BEARBEITEN EINES WERKSTÜCKS MIT EINEM HOCHENERGETISCHEN BEARBEITUNGSSTRahl

Title (fr)

PROCÉDÉ DE SURVEILLANCE D'USINAGE ET DISPOSITIF D'USINAGE D'UNE PIÈCE AU MOYEN D'UN FAISCEAU D'USINAGE DE HAUTE ÉNERGIE

Publication

**EP 2714322 A1 20140409 (DE)**

Application

**EP 12726585 A 20120601**

Priority

- DE 102011103282 A 20110603
- EP 2012002341 W 20120601

Abstract (en)

[origin: WO2012163545A1] A method for monitoring the machining of a workpiece with a high-energy processing beam comprises the steps of: recording an electronically evaluable image which contains at least the point of incidence of the processing beam on the workpiece; generating actual image data; comparing the actual image data with nominal image data; generating an image error signal if the actual image data deviate from the nominal image data; detecting, synchronously with the generation of the actual image data, the actual processing parameters controlling the process to be monitored; comparing the actual processing parameters with nominal processing parameters; generating a process error signal if the actual processing parameters deviate from the nominal processing parameters; generating an error signal when an image error signal and a processing error signal are present simultaneously; and initiating measures if an image error signal is present.

IPC 8 full level

**B23K 26/03** (2006.01); **B23K 26/04** (2014.01)

CPC (source: EP)

**B23K 26/032** (2013.01); **B23K 26/0344** (2015.10); **B23K 26/042** (2015.10); **B23K 26/044** (2015.10)

Citation (search report)

See references of WO 2012163545A1

Designated contracting state (EPC)

AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

DOCDB simple family (publication)

**DE 102011103282 A1 20121206; DE 102011103282 B4 20150903; EP 2714322 A1 20140409; WO 2012163545 A1 20121206**

DOCDB simple family (application)

**DE 102011103282 A 20110603; EP 12726585 A 20120601; EP 2012002341 W 20120601**